

S-LP60N06D2

60V P-Channel Power MOSFET

1. FEATURES

- Low thermal impedance.
- Fast switching speed.
- We declare that the material of product compliance with RoHS requirements and Halogen Free.
- S-prefix for automotive and other applications requiring unique site and control change requirements; AEC-Q101 qualified and PPAP capable.

2. APPLICATIONS

- Load Switches
- DC/DC Conversion
- Motor Drives

3. DEVICE MARKING AND RESISTOR VALUES

Device	Marking	Shipping
S-LP60N06D2	P60N06D2	2500pcs/Tape&Reel

4. MAXIMUM RATINGS

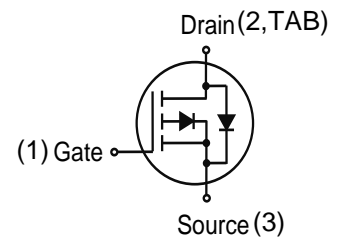
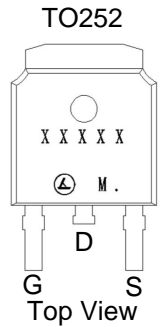
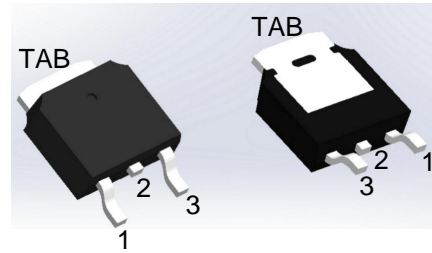
Parameter		Symbol	Limits	Unit
Drain-to-Source Voltage		VDS	-60	V
Gate-to-Source Voltage		VGS	± 20	V
Continuous Drain Current	TC=25°C	ID	-59	A
	TC=100°C		-35	
Pulsed Drain Current (Note 2)		IDM	-236	A
Avalanche Current		IAS	-45.6	A
Avalanche Energy(L=0.1mH)		EAS	104	mJ
Power Dissipation	TC=25°C	PD	41	W
	TC=100°C		16	
Operating Junction and Storage Temperature Range		Tj/Tstg	-55~+150	°C

5. THERMAL CHARACTERISTICS

Parameter	Symbol	Max	Unit
Junction-to-Ambient(Note 1)	RθJA	50	°C/W
Junction-to-Case	RθJC	3	

Note:1.Surface mounted on "1.5in x 1.5in" FR4 board using 1*1 in pad, 2 oz Cu.

2.Pulse width limited by maximum junction temperature.



6. ELECTRICAL CHARACTERISTICS (T_J= 25°C)

Characteristic	Symbol	Min.	Typ.	Max.	Unit
Static					
Drain–Source Breakdown Voltage (V _{GS} = 0 V, I _D = -250 μA)	V(BR)DSS	-60	-	-	V
Zero Gate Voltage Drain Current (V _{DS} = -48 V, V _{GS} = 0 V)	I _{DSS}	-	-	-1	μA
Gate–Body Leakage Current (V _{DS} = 0 V, V _{GS} = ± 20 V)	I _{GSS}	-	-	±100	nA
Gate Threshold Voltage (V _{DS} = V _{GS} , I _D = -250 μA)	V _{GS(th)}	-1	-	-3	V
Static Drain–Source On–State Resistance(Note 3) (V _{GS} = -10 V, I _D = -9 A) (V _{GS} = -4.5 V, I _D = -8 A)	R _{DS(on)}	-	-	9.8 11.8	mΩ
Diode Forward Voltage (V _{GS} = 0 V, I _S = -3.6 A)	V _{SD}	-	-	-1.2	V
Dynamic					
Input Capacitance	(V _{DS} = - 30 V, V _{GS} = 0 V, f = 1MHz)	C _{iss}	-	7044	pF
Output Capacitance		C _{oss}	-	385	
Reverse Transfer Capacitance		C _{rss}	-	355	
Total Gate Charge	(V _{DS} = -30 V, V _{GS} = -4.5 V, I _D = -9 A)	Q _g	-	66	nC
Gate-Source Charge		Q _{gs}	-	18	
Gate-Drain Charge		Q _{gd}	-	26	
Turn-On Delay Time	(V _{DS} = -30 V, R _L = 3.3 Ω, I _D = -9 A, V _{GEN} = -10 V, R _{GEN} = 6 Ω)	t _{d(on)}	-	24	ns
Rise Time		t _r	-	30	
Turn-Off Delay Time		t _{d(off)}	-	324	
Fall Time		t _f	-	120	
Gate Resistance (V _{DS} = 0 V, V _{GS} = 0 V, f = 1.0MHz)	R _g	-	6	-	Ω

3.Pulse test: PW ≤ 300us duty cycle ≤ 2%.

7. ELECTRICAL CHARACTERISTICS CURVES

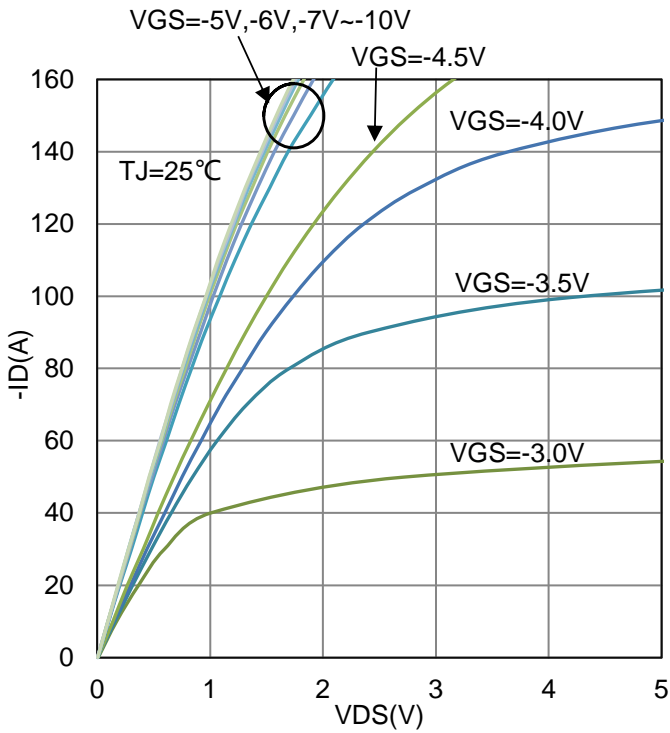


Figure 1. -ID vs. -VDS

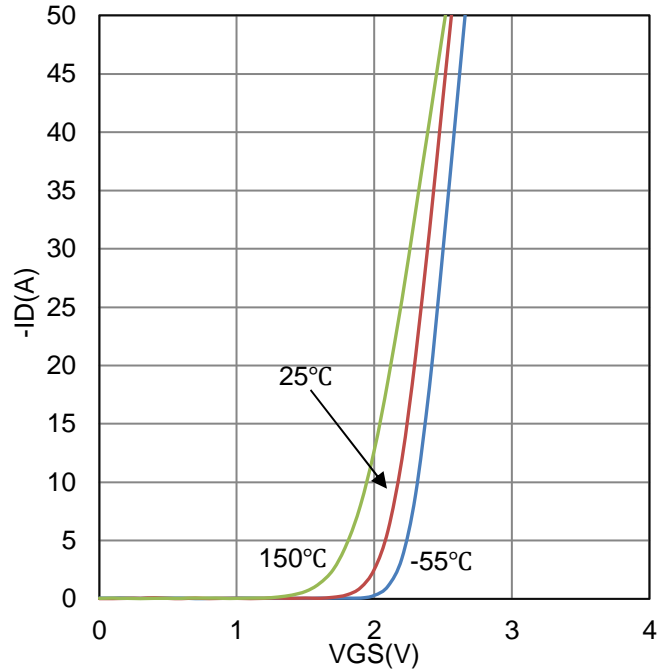


Figure 2. -ID vs. -VGS

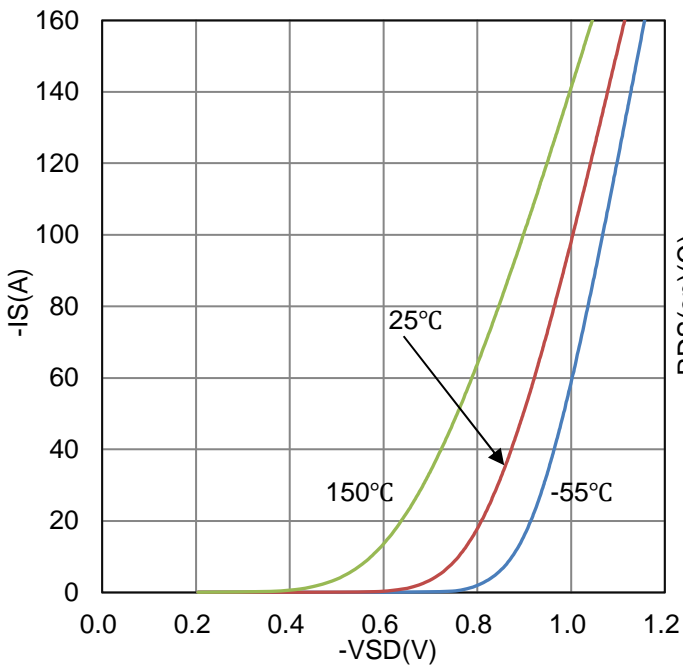


Figure 3. -IS vs. -VSD

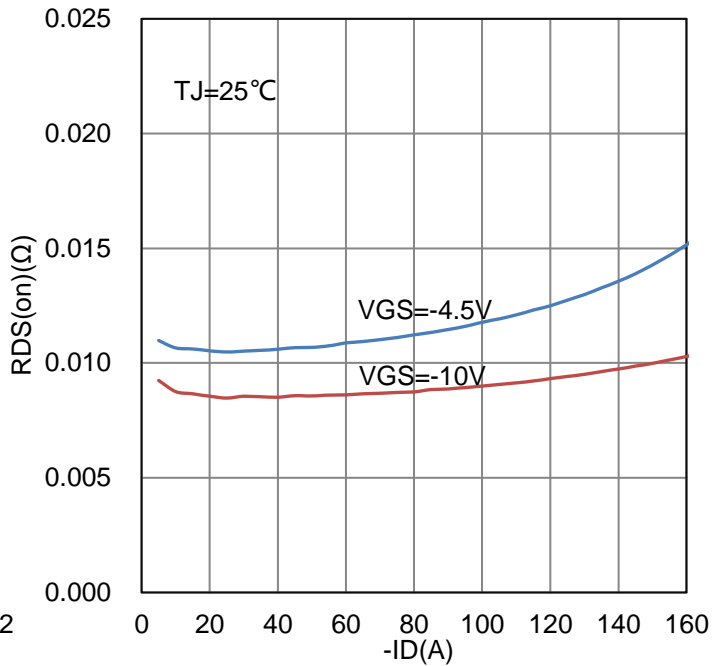


Figure 4. RDS(on) vs. -ID

7. ELECTRICAL CHARACTERISTICS CURVES(Con.)

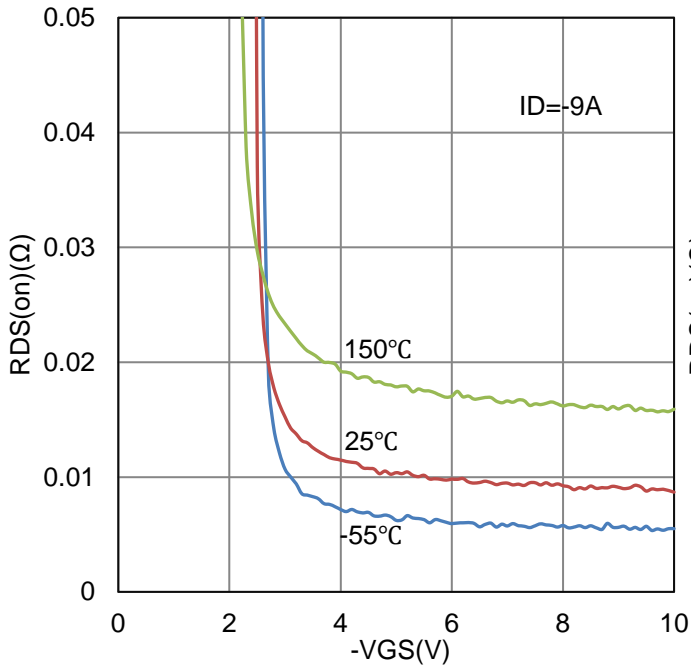


Figure 5. RDS(on) vs. -VGS

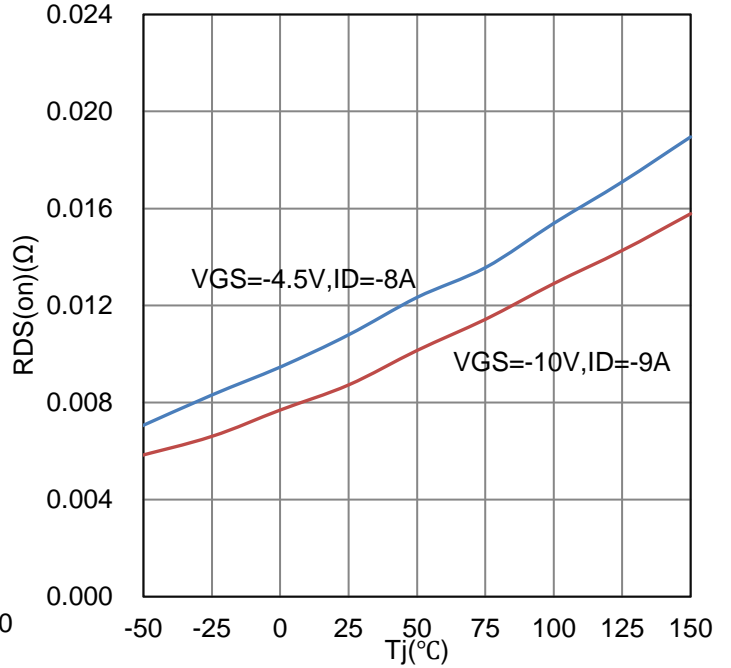


Figure 6. RDS(on) vs. Tj

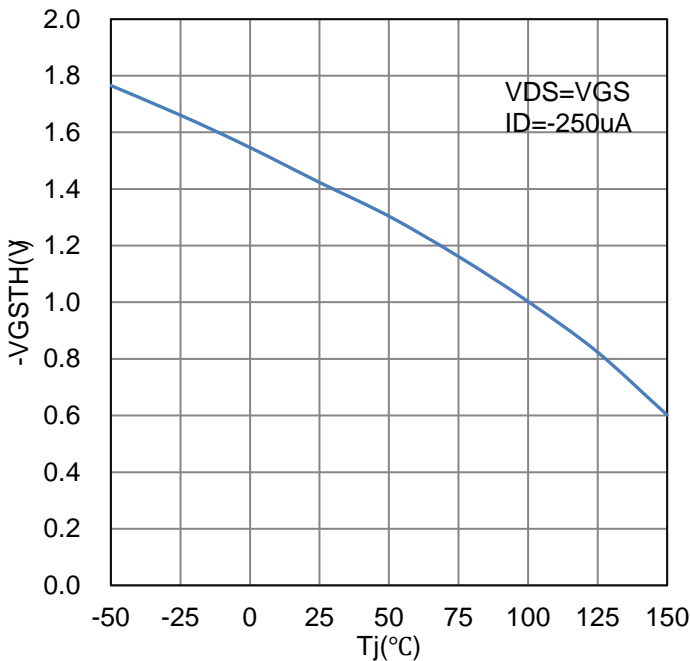


Figure 7. -VGSth vs. Tj

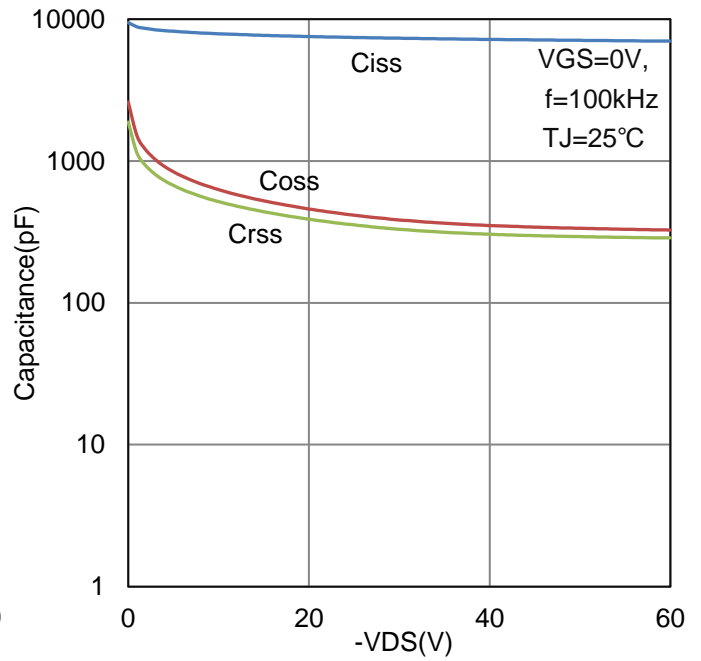


Figure 8. Capacitance

7. ELECTRICAL CHARACTERISTICS CURVES(Con.)

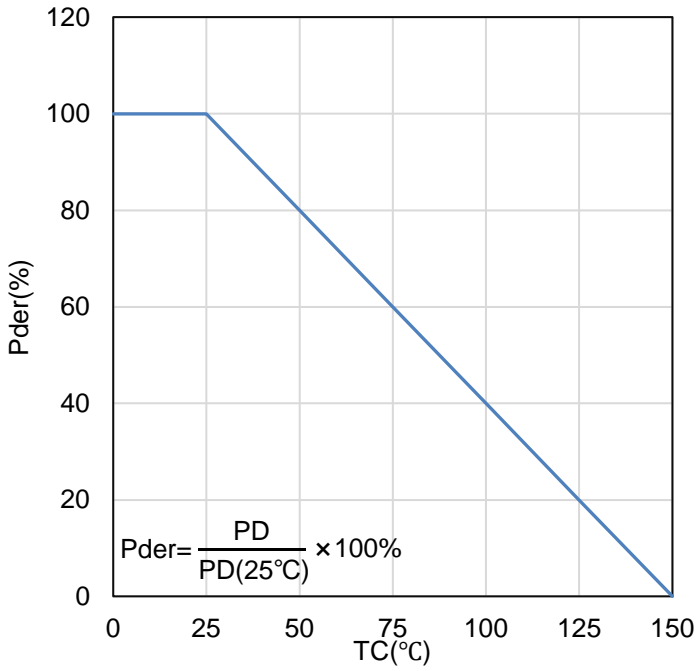


Figure 9. Normalized Derating Curve

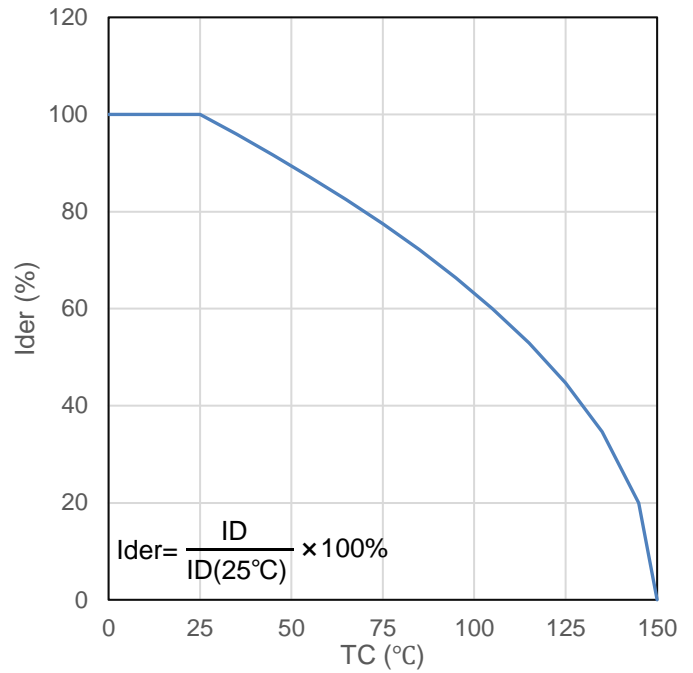


Figure 10. Normalized drain Current

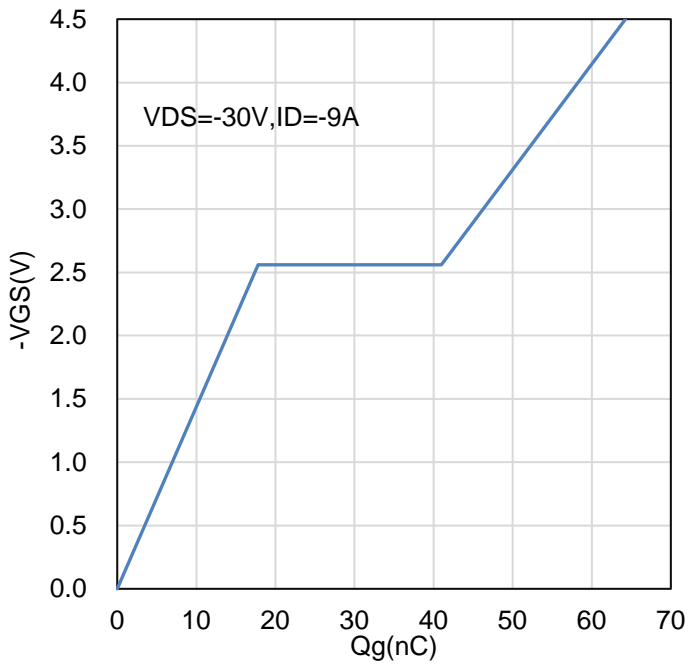


Figure 11. -VGS vs. Qg

7. ELECTRICAL CHARACTERISTICS CURVES(Con.)

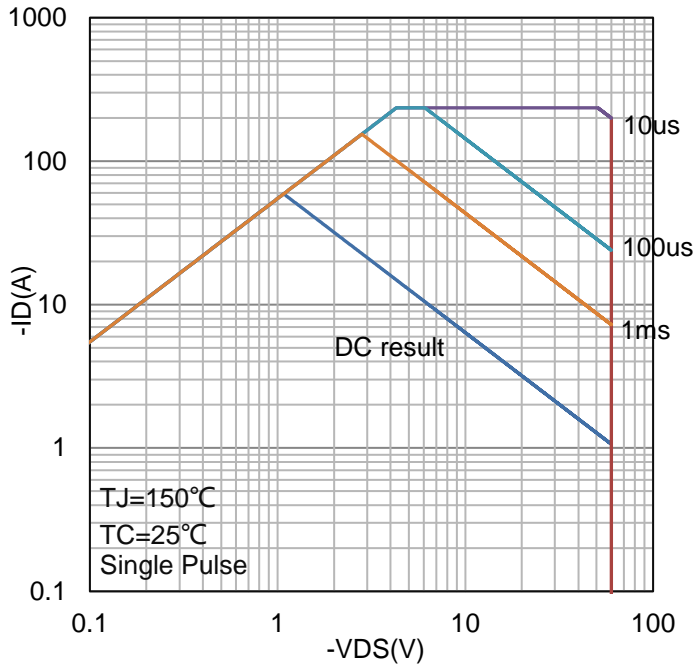


Figure 12.Safe Operating Area

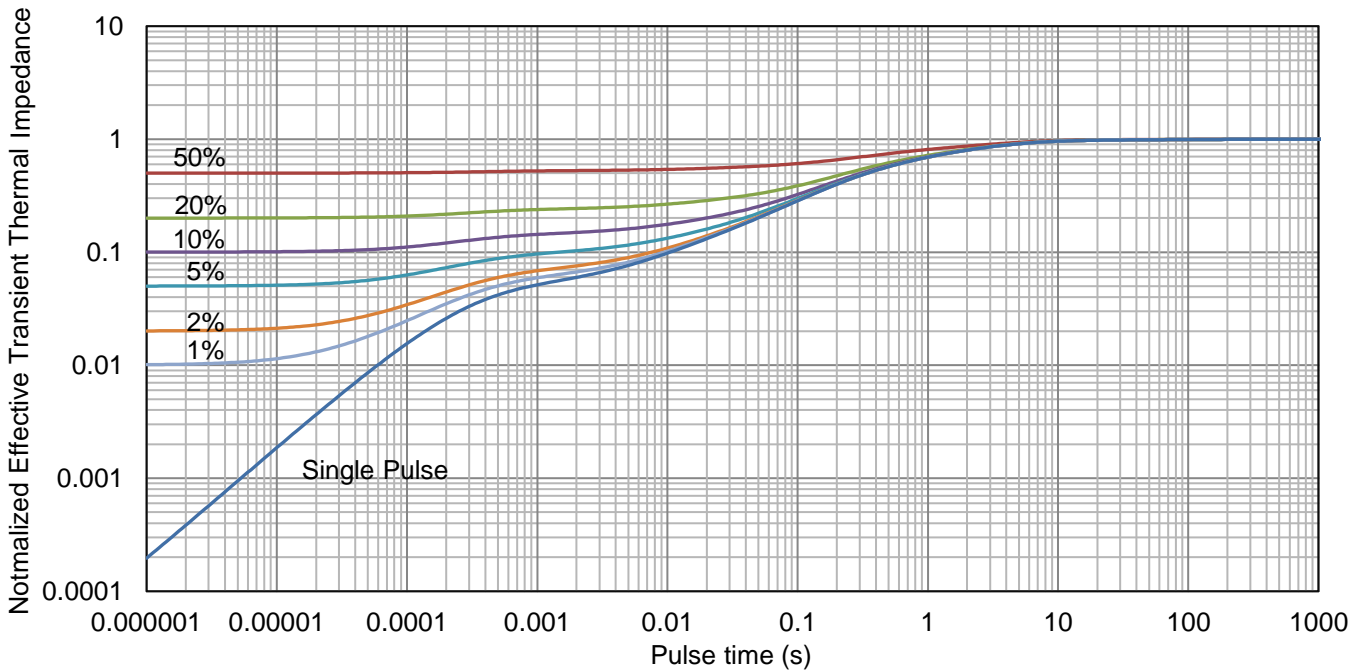
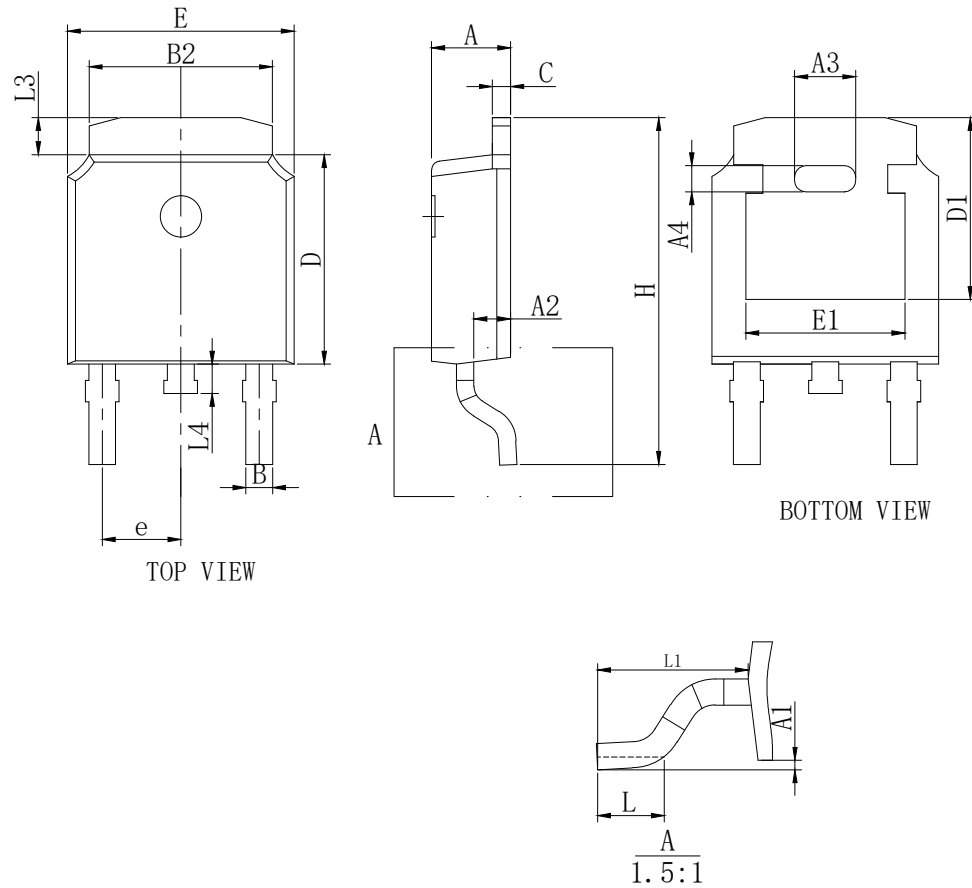


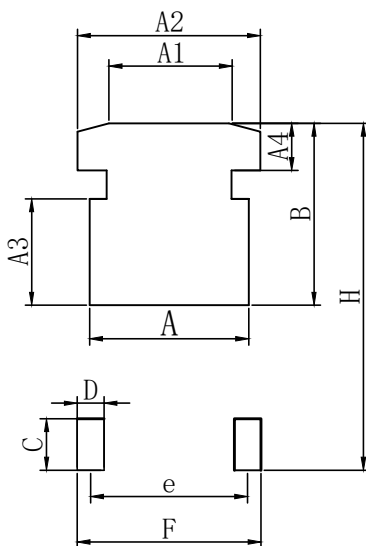
Figure 13.Thermal Response

8. OUTLINE AND DIMENSIONS



DIM	MILLIMETERS		
	MIN	NOM	MAX
A	2.15	2.30	2.45
A1	0	-	0.20
A2	0.90	1.07	1.17
A3	1.58	1.78	1.98
A4	0.56	0.76	0.96
B	0.68	0.78	0.88
B2	5.20	5.33	5.46
C	0.49	-	0.58
D	5.90	6.10	6.30
D1	5.30REF		
E	6.40	6.60	6.80
E1	4.63	4.83	5.03
e	2.286BSC		
H	9.8	10.10	10.4
L	1.09	1.29	1.49
L1	2.90REF		
L3	0.88	1.08	1.28
L4	0.55	0.80	1.05

9. SOLDERING FOOTPRINT



DIM	MIN(mm)
A	6.03
A1	4.50
A2	6.46
A3	4.10
A4	2.37
B	6.50
C	2.50
D	1.68
e	4.57(TYP)
H	12.35
F	6.25

DISCLAIMER

- Curve guarantee in the specification. The curve of test items with electric parameter is used as quality guarantee. The curve of test items without electric parameter is used as reference only.
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